LC Detector R&D

- International LC R&D Committee Report -(presented by H. Yamamoto, Santa Cruz 2002/6)

draft: blueox.uoregon.edu/~jimbrau/LC/LCrandd.ps

Still not complete. Soliciting comments.

Following a suggestion by LC Worldwide Study Commitee, a committee was formed in 2001 to draft a report to

- Describe the R&D needed for LC.
- List R&D's currently performed.
- Point out areas missing or not well-covered.

To help newcomers find R&D work (and get funded), to avoid unnecessary duplications, and to make sure no big holes are left.

In short, to maximize the effectiveness of R&D's worldwide.

Committee members

Asia: Yoshiaki Fujii, Hwanbae Park, Hitoshi Yamamoto Europe: Chris Damerell, Rolf-Dieter Heuer, Ron Settles N. America: Jim Brau, Gene Fisk, Keith Riles

- Held meetings at LC workshops (Kracow, Beijing, Chicago) and communicated by Email.
- Basic structure of the draft decided at the Beijing ACFA meeting 2001.
- Actual dividing up of drafting works at the Chicago LC workshop, Jan. 2002.

Early on (\sim Beijing meeting), we decided:

- Not prescriptive or exhaustive.
- Innovative R&D's not listed are encouraged.
- Only software efforts directly related to hardware designs are included.
- LHC-specific R&D's not included.
- Set up one cross-region website for each subdetector maintained by corresponding experts. (to keep the global organization effective).

It does not prescriptively list up areas of needed R&D's. (let readers decide on their own)

> The report will be undoubtedly incomplete, but may be useful if not taken too seriously. (was useful to me)

Brief Description of the Report

Where LC is

- Compete with LHC (in a broad sense).
- Need to make full use of the available luminosity.
- Performances far better than LHC in each subdetector taking advantages of the lower rates and radiation.
 (Detector R&D efforts that match those of the machine are warranted.)

Detector performance goals

• vertexing: $\sigma_{r\phi,z}(ip) \leq 5 \,\mu \mathrm{m} \oplus \frac{10 \,\mu \mathrm{m \, GeV/c}}{p \sin^{3/2} \theta}$, (1/5 r_{beampipe} , 1/30 pixel size, 1/30 thin w.r.t LHC)

(Example) b, c tagging. $(H \rightarrow b\bar{b} \text{ vs } c\bar{c})$ $t \rightarrow 3 \text{jets reconstruction.}$

• central tracking: $\sigma(\frac{1}{p_t}) \le 5 \times 10^{-5} (\text{GeV/c})^{-1}$ (~ 1/10 LHC. 1/6 material in tracking volume.)

(Example) M_H by $e^+e^- \to ZH \to \ell^+\ell^- X$ $M_{\tilde{\ell}}$ by $e^+e^- \to \tilde{\ell}\tilde{\ell} \to \ell^+\ell^-\chi^0\chi^0$

Detector performance goals (cont'd)

• forward tracking: $\sigma(\frac{1}{p_t}) \leq 3 \times 10^{-4} (\text{GeV/c})^{-1}$, $\sigma(\delta\theta) \leq 2\mu \text{rad to } |\cos \theta| \sim 0.99$.

(Examples) SUSY *t*-channel production. $d\mathcal{L}/dE$ by forward Bhabha.

• energy-flow: $\frac{\sigma_E}{E} \simeq 0.30 \frac{1}{\sqrt{E(\text{GeV})}}$ (1/200 calorimeter granularity w.r.t. LHC)

jet 4-momentum measurement. (e.g. $Z, W, H \rightarrow 2$ jets, $t \rightarrow 3$ jets)

• hermeticity

(only ~ 10 mrad hole along beamline)

Missing energy measurement.

Generic LC detector



- Instrumented IP mask.
- Pixel-based vertex detector.
- High B-field (≥ 3T) (For *p*-resolution.
 Also,squeeze pair background)
- ECAL&HCAL within B-field.
- Flux-return as muon detector. (catches hadronic shower tail)





'Small' design (Silicon-based central tracker)



R&D Presently Performed

1. Tracking System

Vertex Detector

Tradeoffs:

Radius \leftrightarrow background (e^+e^- pairs)

Spacial resolution/material ↔ readout speed/radiation hardness

- Pair background: stay-clear $\propto 1/B$.
- Neutron ~ 3×10⁸/cm²/yr:
 ≪ LHC, but with a large uncertainty.
- Readout speed: particularly important for Tesla. occupancy $\sim 4\%$ if taken for a full 1ms train.

Vertexing Options

Charge-Coupled Devices (CCD's) (default)

Pros: proven performance at SLD Small pixel size $\sim (20 \mu m)^2$ Good spacial resolution (< 5 μ m) Relatively easy to thin

Cons: slow readout modest radhardness probably needs to be cooled

- LCFI (LC Flavour Identification) collaboration: UK (Bristol,Glasgow,Lancaster,Liverpool,Oxford,RAL)
- US collaboration (Oregon, Yale)
- Japanese collaboration (KEK, Niigata, Tohoku, Saga)

Charge-Coupled Devices (CCD's)

R&D items

- Thinning Si bulk to ${\sim}100\mu{
 m m}$ (0.1% $X_0/{
 m lyr}$)
- Mechanical: e,g, tension support (eliminate ribs)
- Radhadening: instrinsic radhardness
 + damage control (trap filling)
- Faster clock speed and/or parallel readout. Greater integration of readout electronics.
- Room-temperature operation.

Active Pixel Sensors (APS)

- Hybrid pixel sensors (i.e. bump-bonded readout/sensor) (CERN, Helsinki, INFN, Krakow, Warsow)
 R&D items
 - material reduction
 - smaller pitch
 - capacitively-coupled readout to reduce #channel
- Monolithic active pixel sensors (MAPS).
 CMOS image sensor technology. Pixel size ~CCD Commercial fab process. Readout/sensor on one chip. (Strasbourg, RAL)
 R&D items
 - large-area sensor
 - fast readout
 - thinning
- DEPFET (depleted FET) (MPI-Munich)

Central Tracker

Global optimization study (simulation) (Colorado, Michigan, Indiana, Santa Cruz, Wayne State) tradeoffs: track finding, background, material budjet, bunch discrimination, calorimetry interface.

Two basic types:

• Gaseous

large, many samplings/trk

dE/dx π/K separation promissing.

- Jet chamber
- TPC

• Silicon

small, ~5 samplings/trk No dE/dx π/K separation. (may be useful for new long-life heavy particles) Jet Chamber

(KEK)

R&D items

- Controling/monitoring wire sag.
- Gas gain saturation (dE/dx and 2-track separation)
- Cell design for Lorentz angle (3 Tesla).
- Gas mixture study.
- Neutron background (~2khits/train).
- Maintenance of resolution (85μ m) and 2-track separation (2mm) over the volume and time.

TPC (Time Projection Chamber)

Europe (Aachen, DESY/Hamburg, Karlsruhe, Krakow, MPI-Munich, NIKHEF, Novosibirsk, Orsay/Sacley, Rostok)

N. America (Carleton,/Montreal, LBNL, MIT)

TPC R&D items

Novel readouts: GEM, MicroMEGAS, silicon-based.
 Avoid high-tension wires (reduce material of endplate).
 High-granurarity wire readout as backup.

• Gas mixture

(resolution vs speed tadeoff)
(quenching vs neutron background tradeoff)

TPC R&D items (cont'd)

• Electronics

integration for 10^6 pads, high-speed sampling (> 20MHz), neighbouring pads.

- Mechanical design: Cooling, material reduction.
- Space charge: distortion correction.
- Calibration: laser, "z"-type chamber.
- Readout simulation: compare with prototype devices.

Si Tracker (NLC S option)

A 5-layer Si tracker as the central tracking device in high-B field (5Tesla) ($r_{\text{max}} = 1.25$ m, L/2 = 1.67m)

• Si drift detector

(Wayne State)

- Thin substrates/mechanical support.
- Improve spacial resolution (< 10μ m).
- Increase drift length (reduce channels).
- Lower-mass front-end readout.

• Si microstrip

(Santa Cruz, SLAC)

- Thinner substrates/mechanical support.
- Long ladders (longer shaping time for low noise).
- Power switching (to match trains).
- Lorentz angle effect.
- Double-sided readout.
- Pulse-height information (time walk, dE/dx)

Alignment

Could reduce the requirement on mechanical rigidity. based on the interferometer scheme of ATLAS

Forward Tracker

Silicon microstrip disks to cover down to $|\cos \theta| = 0.99$ (8 deg) First few layers could be pixel sensors (TESLA TDR)

(Santa Cruz, SLAC)

simulation and protyping together with the Si tracker R&D.

Intermediate Tracker

Place between the vertex detector and the central tracker to aid track matching between them and to improve momentum resolution.

Relevant R&D's by (LPNHE-Paris, Santa-Cruz/SLAC, Wayne State)

Additional Trackers

- Silicon External Tracker (SET) Just after TPC (endcap and barrel) (LPNHE-Paris) R&D: Cost reduction.
- Straw chambers (behind TPC endcap) (DESY)
 R&D: spacial resolution, material thickness, bunch tagging, calorimeter sprashback.
- Sicintillating fibre tracker
 between Vertexing and TPC (Indianna)
 R&D: timing precision, material thickness.

2. Calorimeters

Plays important roles in jet 4-momentum reconstruction

EFA (Energy-flow algorithm):

Combine information from the trackers, the calorimeters, and also the muon system, avoid double counting, assign appropreate weights \rightarrow jet 4-momentum.

Simulation studies:

CALICE collaboration, KEK, Colorado, Oregon/SLAC.

ECAL

• Si-W calorimeter

High granurarity ($\sim 1 \text{ cm}^2$), but expensive.

(CALICE, Oregon/SLAC)

R&D items:

- Segmentation optimization (cost reduction).

- Prototype construction/test (CALICE 2004).

• Tile-fibre calorimeter

Modest granurarity (4×4 cm²)

(KEK, Niigata, Tsukuba)

R&D items:

- Segmentation optimization.
- fibre configuration.
- Prototype construction/test.

ECAL (cont'd)

- Showermax detector (for tile-fibre) Inserted near showermax to aid granurarity.
 - scintillator strips (Shinshu/Konan)
 - silicon pads.

• Shashlik calorimeter

Fibres run londitudinally.

Londitudinal segmentation is an issue.

(TESLA TDR)

R&D items:

- Londitudinal segmentation
 - scintillating fibres of different decay times
 - photodiodes to readout the front part.
- Scintillator strip calorimeter

Orthogonally arranged. (Tsukuba)

HCAL

• Tile-fibre calorimeter

Larger granurarity than the ECAL version.

Fe: good for effective Moliere radius.

Pb: hardware compensation at 4mm/1mm sampling.

(CALICE, KEK, Kobe/Konan)

R&D items:

- Granurarity optimization.
- Optimization of absorber material.
 (hardware compensation)
- Prototype construction (also tested with ECAL)
- Photon detectors in high B field:
 APD, HPD, HAPD, MRD, EBCCD.

HCAL (cont'd)

• Digital calorimeter

Very-high granurarity (~ 1cm²) with 1-bit readout.
Use granurarity also for compensation.
('software compensation')
(CALICE, U. Texas)
Read out: RPC or wires as default.

R&D items:

- Prototype (tile/digital interchangeable)
- New readouts (GEM, VLPC).

3. Muon Detector

Muon ID + hadron shower tail

Fe as flux return

RPC, Scintillation counter strips, wires as readout. (INFN-Frascati, Kobe, Tohoku, N. Illinois, FNAL)

R&D items needed:

• Mechanical design.

Support system of the large heavy detector.

• Simulation studies.

Tracking algorithms EFA Beam backgrounds Hadron punch-throughs

• Hardware R&D's

Prototype design and beam tests.

4. Particle ID (hadrons)

dE/dx will be available for gaseous cental trackers. (if care is taken not to sacrifice dE/dx) Do we need a Cerenkov device?

In general, vertexing is a powerful flavor id at LC. How useful is additional hadron id? (is this a settled question?)

Giga-Z B-physics may need such device. $(B^- o D_{1,2}K^-, \ B_s o D_s^+K^-)$

DELPHI/SLD types occupy a large valume before ECAL. \rightarrow DIRC type - focusing. (Colorado State)

5. IP Instrumentation

• Beam energy.

 10^{-4} needed in general: possible with an improved beam spectrometer of SLC/LEP. 10^{-5} needed for Giga-Z: Possible?

• Differential luminosity

Critical in m_t threshold scan etc. Low-angle Bhabha accolinearity.

• Polarization.

Giga-Z: 10^{-3} polarization determination needed.

• Beam profile.

Hit pattern near Lum. Mon. of pairs. Pixel-based disk system R&D (Hawaii, KEK, Tohoku).

6. Detectors for the $\gamma\gamma$ Collider

 $\gamma\gamma$ collider events $\sim e^+e^-$ collider events.

 $\gamma\gamma$ specific:

• Laser system.

Inside(NLC) or outside(Max Born) the detector Interference with low-angle detectors.

• Large beam disruption.

Outgoing path.

Beam background (10^{11} neutrons/cm²/yr at IP)

 \rightarrow needs to be improved (dose or CCD)

• 'Resolved photon' events $(\gamma \rightarrow q\bar{q})$ High rate - every random trigger has a track. (LLNL)

Items Currently Missing in the Report

Low-angle calorimeters (lum.mon., instrumented mask etc.)

Trigger

. . .

Challenges are in front of us to design/build a detector that takes full advantage of the luminosity of LC. They seem certainly be achievable if we put all forces together.